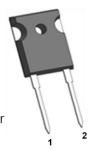


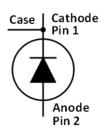
IV3D12030T2 - 1200V 30A SiC Schottky Diode

Features

- Max Junction Temperature 175°C
- High Surge Current Capacity
- Low Forward Voltage
- Extremely Fast Reverse Recovery Time
- Reduced Losses in Associated MOSFET
- High-Frequency Operation
- Temperature Independent Switching Behavior
- Positive Temperature Coefficient on V_F

Outline







Rev1.1

TO247-2

Applications

- Solar Power Boost
- Inverter Free Wheeling Diodes
- Vienna 3-Phase PFC
- EV Charger Piles
- Switching Mode Power Supplies

Marking Diagram

3D12030T2 YYWWZ XXXX 3D12030T2 = Specific Device Code YY = Year

WW = Work Week
Z = Assembly Location
XXXX = Lot Traceability

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	
V_{RRM}	Reverse voltage (repetitive peak)		V	
V _{DC}	DC blocking voltage	1200	V	
I _F	Forward current (continuous) @Tc=25°C	96.0	А	
	Forward current (continuous) @Tc=135°C	46.2	А	
	Forward current (continuous) @Tc=155°C	30	А	
I _{FSM}	Surge non-repetitive forward current	280	А	
	sine halfwave @Tc=25°C tp=10ms	200		
	Surge repetitive forward current (Freq=0.1Hz, 100cycles)	240	А	
FRM	sine halfwave @Tamb=25°C tp=10ms	240		
P _{tot}	Total power dissipation @ Tc=25°C	428	١٨/	
Ptot	Total power dissipation @ Tc=150°C	71.4	W	
∫ i²dt	I ² t value @Tc=25°C tp=10ms	392	A^2s	
Tstg	Storage temperature range	-55 to 175	°C	
Tj	Operating junction temperature range	-55 to 175	°C	
М	Mounting torque (M3 screw)	0.7	Nm	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



Electrical Characteristics

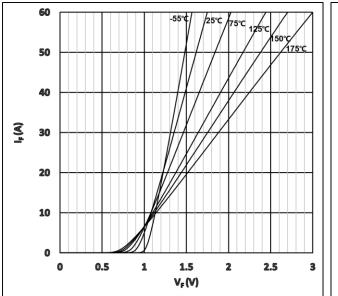
Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V _F	Forward Voltage	1.36	1.65	V	I _F = 30 A T _J =25°C	Eig 1
VF	Forward Voltage	1.88	2.50	V	$I_F = 30 \text{ A T}_J = 175^{\circ}\text{C}$	Fig. 1
I_R	Reverse Current	10	300		$V_R = 1200 \text{ V T}_J = 25^{\circ}\text{C}$	Fig. 2
IR	Reverse Current	60	1000	μΑ	V _R = 1200 V T _J =175°C	rig. Z
		2075			$V_R = 1 \text{ V}, T_J = 25^{\circ}\text{C}, f = 1 \text{ MHz}$	
С	Total Capacitance	180		рF	$V_R = 400 \text{ V}, T_J = 25^{\circ}\text{C}, f = 1 \text{ MHz}$	Fig. 3
		137			$V_R = 800 \text{ V}, T_J = 25^{\circ}\text{C}, f = 1 \text{ MHz}$	
					$V_R = 800 \text{ V}, T_J = 25^{\circ}\text{C},$	
Qc	Total Capacitive Charge	192		nC	$Q_{c} = \int_{0}^{VR} C(V) dV$	Fig. 4
	Canaditanea Stored				$V_R = 800 \text{ V}, T_J = 25^{\circ}\text{C},$	
Ec	Capacitance Stored Energy	54.9		μЈ	$E_{\scriptscriptstyle C} = \int_0^{VR} C(V) \cdot V dV$	Fig. 5

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Note
R _{th(j-c)}	Thermal Resistance from Junction to Case	0.35	°C/W	Fig.7



Typical Performance



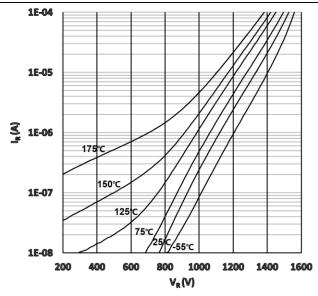
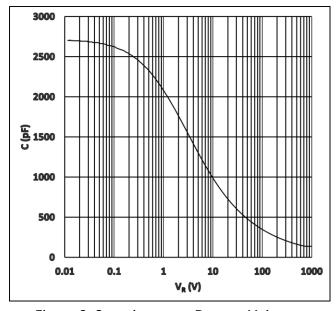
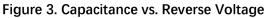


Figure 1. Typical Forward Characteristics

Figure 2. Typical Reverse Characteristics





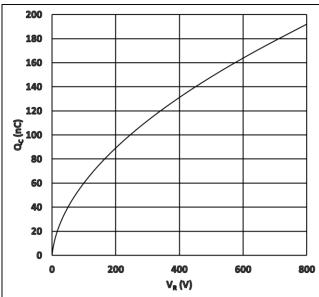
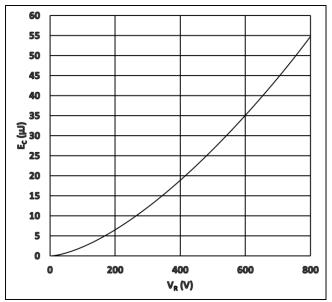


Figure 4. Recovery Charge vs. Reverse Voltage





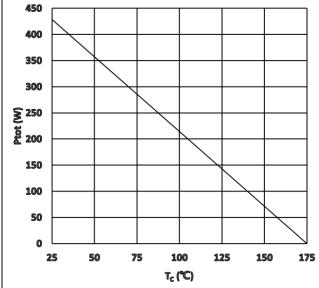
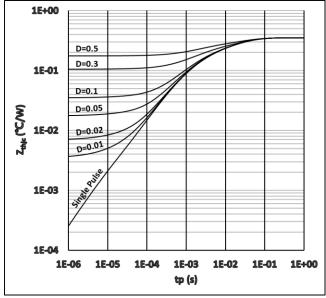


Figure 5. Capacitance Stored Energy

Figure 6. Power Derating



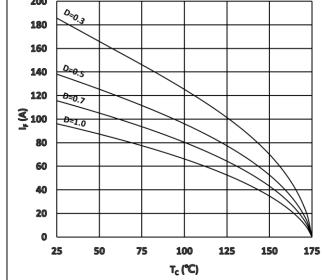


Figure 7. Transient Thermal Impedance

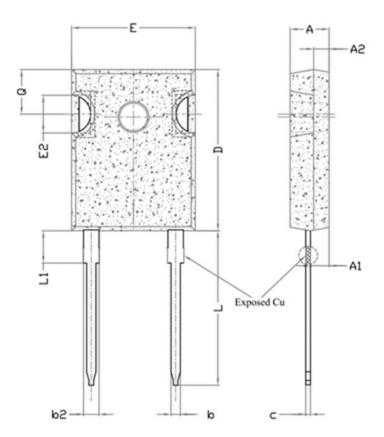
Figure 8. IF as a Function of Temp.

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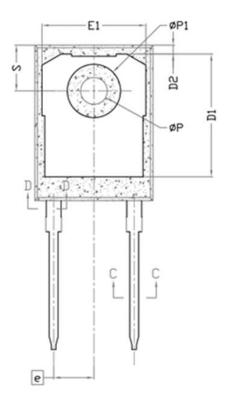
200

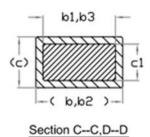


Package Dimensions



Dimensions In Millimeters				
SYMBOL	MIN.	MAX.		
Α	4.83	5.21		
A1	2.20	2.60		
A2	1.50	2.49		
b	1.00	1.40		
b1	0.99	1.35		
b2	1.80	2.41		
b3	1.65	2.39		
С	0.50	0.70		
c1	0.38	0.70		
D	20.30	21.10		
D1	13.08	-		
D2	0.51	1.35		
Е	15.45	16.13		
E1	13.10	-		
E2	3.68	5.49		
е	5.44 BSC			
L	19.80	21.00		
L1	-	4.50		
φР	3.50	3.70		
φP1	-	7.40		
Q	5.39	6.20		
S	6.04	6.30		





Note:

- 1. Package Reference: JEDEC TO247, Variation AD
- 2. All Dimensions are in mm
- 3. Slot Required, Notch May Be Rounded or Rectangular
- 4. Dimension D&E Do Not Include Mold Flash
- 5. Subject to Change Without Notice



Notes

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